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# YC201607-ATC4

# **SMD Type Yellow Emitter**

### Features

- Top view 2016 package
- Viewing Angle =  $\pm 60^{\circ}$
- Compatible with infrared and vapor phase reflow solder process
- High reliability
- Ultra bright Yellow
- RoHS compliance

# **Applications**

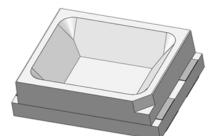
- Optical indicator.
- Switch and Symbol Display.

### Description

The YC201607-ATC4 is an AlGaInP Yellow LED housed in a miniature SMD package. The device has a dominant wavelength of 590nm LED.

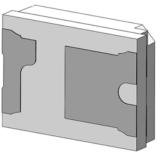
## Package Outline

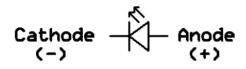
# Schematic



Cathode

Anode







# Absolute Maximum Rating at 25°C

Symbol	Parameters	Ratings	Units	Notes
lF	Continuous Forward Current	40	mA	
IFP	Peak Forward Current	80	mA	1
V <sub>R</sub>	Reverse Voltage	5	V	
T <sub>opr</sub>	Operating Temperature	-40 ~ +85	0C	
T <sub>stg</sub>	Storage Temperature	-40 ~ +100	0C	
T <sub>sol</sub>	Soldering Temperature	260	0C	2
PD	Power Dissipation at(or below) 25°C Free Air Temperature	90	mW	

### Electro-Optical Characteristics TA = 25°C (unless otherwise specified)

#### **Optical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
lv	Luminous Intensity	I <sub>F</sub> =20mA	565	715	900	mcd	3
λd	Dominant Wavelength	I <sub>F</sub> =20mA	585.5	-	594.5	nm	4
θ1/2	Angle of Half Intensity	I <sub>F</sub> =20mA	-	60	-	deg	

#### **Electrical Characteristics**

Symbol	Parameters	Test Conditions	Min	Тур	Max	Units	Notes
VF	Forward Voltage	I <sub>F</sub> =20mA	1.9	2.2	2.5	V	
IR	Reverse Current	V <sub>R</sub> =5V	-	-	1	μA	

Notes:

- 1. IFP Conditions--Pulse Width  $\leq 100 \mu s$  and Duty  $\leq 10\%$ .
- 2. Soldering time  $\leq 10$  seconds.
- 3. Bin Range of Luminous Intensity

Bin Code	Min	Max	Unit	Condition
U2	565	715	mad	l⊧=20mA
V1	715	900	mcd	I⊧=20IIIA

Tolerance of Luminous Intensity ±10%



# YC201607-ATC4 SMD Type Yellow Emitter

#### 4. Bin Range of Dominant Wavelength

Bin Code	Min	Max	Unit	Condition
Y3	585.5	5885		
Y4	588.5	591.5	nm	I⊧=20mA
Y5	591.5	594.5		

Tolerance of Dominant Wavelength: ±1nm

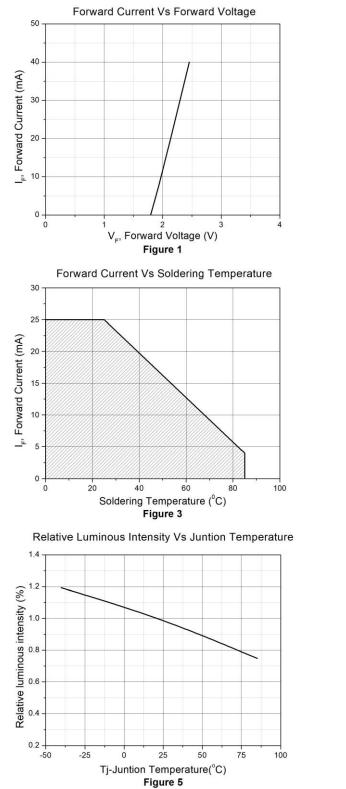
#### 5. Bin Range of Forward Voltage

Bin Code	Min	Max	Unit	Condition
V5	1.9	2.1		
V6	2.1	2.3	V	I⊧=20mA
V7	2.3	2.5		

Tolerance of Forward Voltage: ±0.1V.



# **Typical Characteristic Curves**



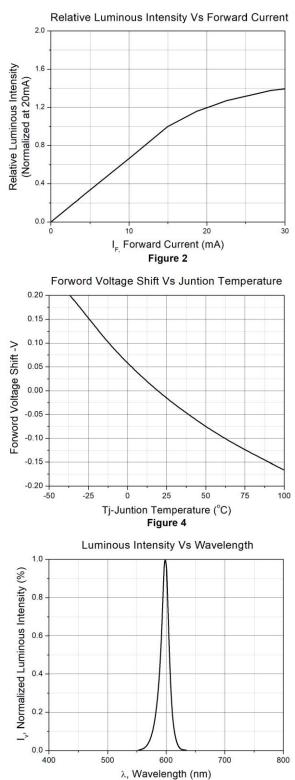
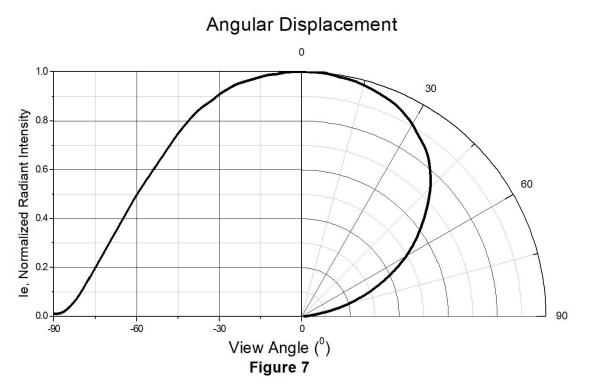


Figure 6

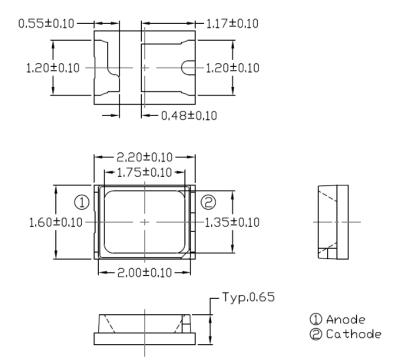


**Typical Characteristic Curves** 



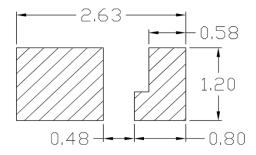


### Package Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.

## Recommended Soldering Mask All dimensions are in mm, unless otherwise stated



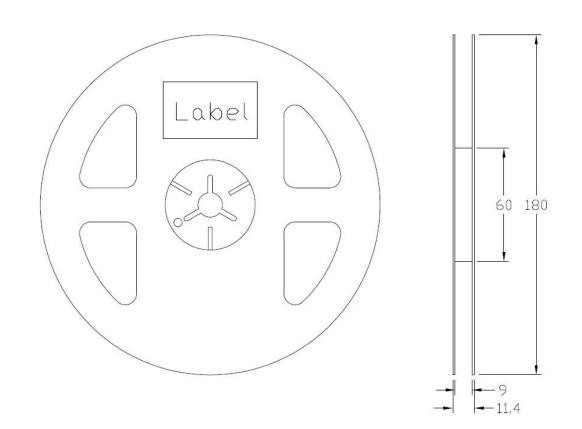
Note: Tolerance unless mentioned is ±0.1mm.

# **Ordering Information**

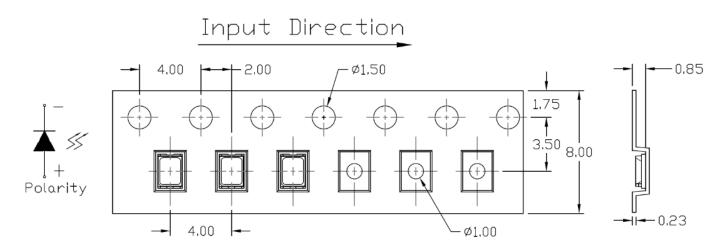
Part Number	Description	Quantity
YC201607-ATC4	Tape & Reel	4000 pcs



## Reel Dimension All dimensions are in mm, unless otherwise stated



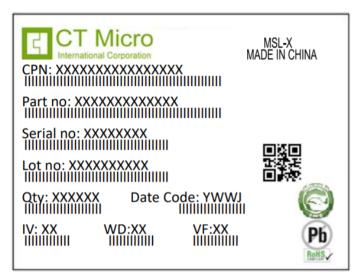
### Tape Dimension All dimensions are in mm, unless otherwise stated



Note: Tolerance unless mentioned is ±0.1mm.



# Label Form Specification



CPN : Customer Part Number Part no: CTM Production Number Serial no: Production Number Lot no: Lot number Q'ty: Packing Quantity Date Code: Manufacture Date IV : Bin Code of Luminous Intensity WD : Bin Code of Dominant Wavelength VF : Bin Code of Forward Voltage MADE IN CHINA: Production Place

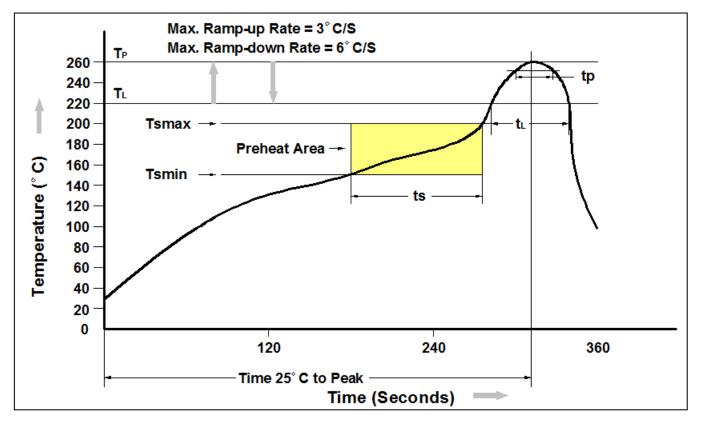
# **Storage Condition**

- 1. Do not open moisture proof bag before the products are ready to use.
- 2. The moisture barrier bag should be stored at 30°C and 90%R.H. max. before opening. Shelf life of non-opened bag is 12 months after the bag sealing date.
- 3. After opening the moisture barrier bag floor life is 168h at 30°C/60%RH. max. Unused LEDs should be resealed into moisture barrier bag. (Refer to J-STD-020 Standard)
- 4. If the moisture absorbent material has faded away or the LEDs have exceeded the storage time, baking treatment should be performed using the J-STD-033 Standard conditions.



# YC201607-ATC4 SMD Type Yellow Emitter

## **Reflow Profile**



Profile Feature	Pb-Free Assembly Profile
Temperature Min. (Tsmin)	150°C
Temperature Max. (Tsmax)	200°C
Time (ts) from (Tsmin to Tsmax)	60-120 seconds
Ramp-up Rate (t∟ to t⊳)	3°C/second max.
Liquidous Temperature (T <sub>L</sub> )	217°C
Time (t <sub>L</sub> ) Maintained Above (T <sub>L</sub> )	60 – 150 seconds
Peak Body Package Temperature	260°C +0°C / -5°C
Time (t <sub>P</sub> ) within 5°C of 260°C	30 seconds
Ramp-down Rate ( $T_P$ to $T_L$ )	6°C/second max
Time 25°C to Peak Temperature	8 minutes max.



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